

HT16561 VFD Digital Clock

Features

- · VFD display 12 hour clock function
- 4.194304MHz crystal oscillation
- · Zero adjust function

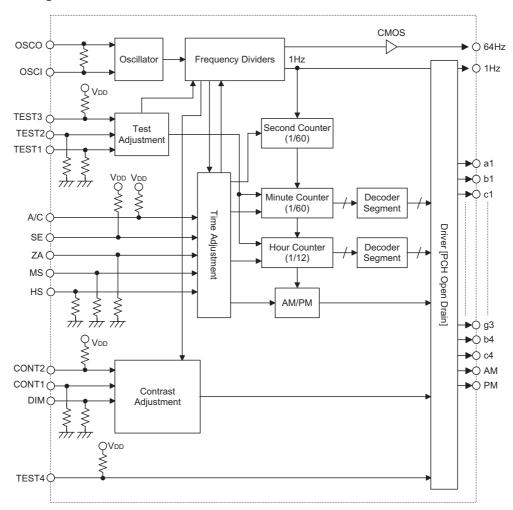
- Integrated voltage regulator permits wide 4V to 16V operating voltage range
- Four level contrast control function
- 44-pin QFP package

General Description

The HT16561 provides direct drive to VFD panels to implement a 12 hour clock function. In addition to obtaining its time base from a 4.194304MHz crystal oscillation source and in having a wide operating voltage, the device also contains a host of other features. These in-

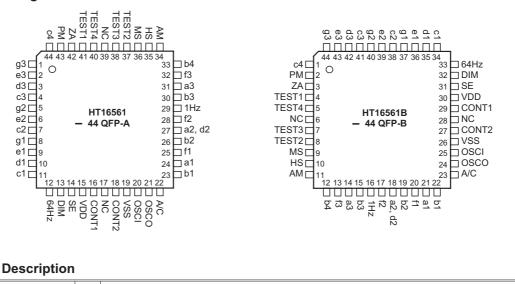
clude a choice of adjustment modes, including single push increment or 2Hz fast forward functions. Additional features are provided in the form of Zero adjustment and four levels of contrast control.

Block Diagram





Pin Assignment

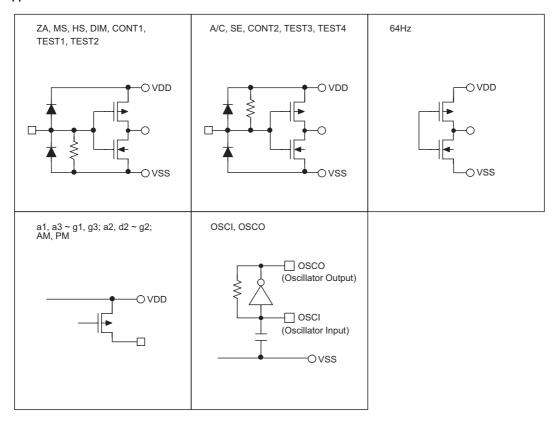


Pin Description

Pin Name	I/O	Description			
VDD	0	High voltage power supply pin.			
VSS	_	Ground pin.			
DIM	I	Illumination level control pins.			
CONT1	ı	Internally connected to pull-down resistors.			
CONT2	I	Illumination level control pins. Internally connected to pull-up resistors.			
A/C	I	When the A/C pin is low, the internal circuits are reset. The reset pulse width should be more than $2\mu s$. Internally connected to a pull-up resistor.			
ZA	I	Zero adjustment pin. Internally connected to a pull-down resistor.			
HS	ı	Hour adjustment pin. Internally connected to a pull-down resistor.			
MS	I	Minute adjustment pin. Internally connected to a pull-down resistor.			
SE	ı	Set enable pin. Internally connected to a pull-up resistor.			
osco	0	Constal and illaton sin			
OSCI	I	Crystal oscillator pin			
TEST1, TEST2	I	IC test pin - should be left open or kept at a low level			
TEST3, TEST4	I	IC test pin - should be left open or kept at a high level			
64Hz	0	64Hz signal output pin for oscillation frequency adjustment			
a1, a3 ~ b2, b4, c4					
AM, PM	0	Segment output pins for VFD			
1Hz					



Approximate Internal Connections



Absolute Maximum Ratings

Logic Supply Voltage V_{SS} -0.3V to V_{SS} +6.5V	Driver S
High Input Voltage V_{SS} -0.3V to V_{CC} +0.3V	High Ou
Driver Output VoltageV _{SS} $-0.3V$ to V_{DD}	Driver O
Driver Output Current (Grid Driver)7mA to +20mA	Storage
Operating Temperature40°C to +85°C	

Driver Supply Voltage	V_{SS} -0.3V to V_{SS} +20V
High Output Voltage	V_{SS} =0.3V to V_{CC} +0.3V
Driver Output Current (Segment	Driver) –10mA to +2mA
Storage Temperature	55°C to +150°C

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

Recommended Operating Conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit
V_{DD}	Power Supply Voltage	4	_	16	V
f _{OSC}	Oscillation Frequency	_	4.194304	_	MHz
t _{OP}	Operating Temperature	-40	_	85	°C

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D.C. Characteristics

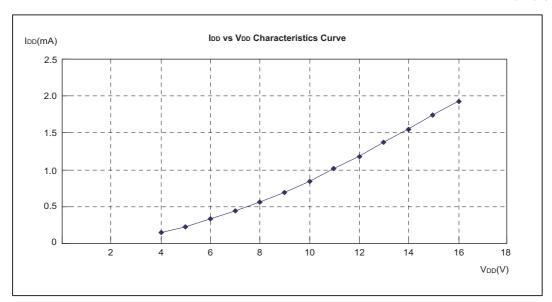
 V_{DD} =6.0V, V_{SS} =0V, Ta=-40°C \sim 85°C

	_	Test Conditions					
Symbol	Parameter	V _{DD}	Conditions	Min.	Тур.	Max.	Unit
V _{IH}	High Input Voltage	6V	_	4.3	_	_	V
V _{IL}	Low Input Voltage	6V	_	_	_	1.0	V
I _{IH}	Hi-level Input Current	6V	V _I =V _{DD} for TEST1, TEST2, ZA, MS, HS, DIM, CONT1	30	_	150	μА
I _{IL1}			V _I =V _{ss} for TEST3, TEST4	-120	_	-800	μА
I _{IL2}	Low-level Input Current	6V	V _I =V _{ss} for A/C	-3	_	-12	μА
I _{IL3}			V _I =V _{ss} for SE, CONT2	-30	_	-150	μА
V _{OL}	Low-level Output current	6V	I _{OL} =V _{SS} for all pin	5.9	_	_	V
V _{OH}	Hi-level Output current	6V	I _{OH} =V _{SS} for 64Hz pin	_	_	0.1	V
I _{OH1}	Output Current	6V	V _{OH} =4.0V for 1Hz, a2, d2, a4, d4, e4, g4	_	_	-2000	μА
I _{OL1}	Output Current	6V	V _{OL} =0V for 1Hz, a2, d2, a4, d4, e4, g4	1	_	_	μА
I _{OH2}	Output Current		V _{OH} =4.0V, Other segment output pins except above	_	_	-1000	μА
I _{OL2}	Output Current		V _{OL} =V _{SS} , Other segment output pins except above	1	_	_	μА
I _{OH3}	Output Current	6V	V _{OH} =5.5V for 64Hz pin	_	_	-100	μА
I _{OL3}	Output Current	6V	V _{OL} =0.5V for 64Hz pin	100	_	_	μА
I _{DD}	Dynamic Current Consumption	6V	$\begin{array}{l} f_{OSC} \!\!=\!\! 4.194304 MHz, \\ No \; load, \; C_{IN} \!\!=\!\! 39pF \!\!\pm\!\! 5\%, \\ C_{OUT} \!\!=\!\! 33pF \!\!\pm\!\! 5\%, \\ C_{I} \!\!=\!\! 70\Omega \!\!\pm\!\! 5\% \end{array}$	_	_	2	mA

Characteristics Curves

V_{DD} vs I_{DD} Characteristics Curve

Ta=25°C





Functional Description

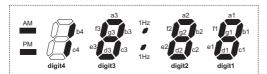
VFD Display Driving

The device can directly drive VFD clock panels dynamically. The clock will be displayed in a 12-hour format with the hours ranging from 1 to 12 and and minutes from 00 to 59. If the most significant numeral is zero then the display will be extinguished.

Segment connections
 A 7-segment display is shown below showing the illumination pattern for each numeral.



As the device is designed for clock applications, four 7-segment displays are required to display the correct time output. The connections for the segments are shown below, however it should be noted that the fourth segment only requires two of its segments to be driven.



Other Pin Functions

The external reset pin A/C is used to reset the internal circuit of the device. When this pin is pulled low the device will be reset, when the pin is allowed to go high, via its internal pull-high resistor, then the display will indicate a "1:00" output.

In the open status, the SE pin is held to "high" level by a pull-high resistor, enabling the inputs from MS, HS and ZA pins. These inputs become invalid by setting this pin to a "low" level externally.

The 64Hz pin allows monitoring of the system frequency to allow frequency adjustments to be executed. As the name suggests, this output pin will continuously output a frequency of 64Hz.

In the open status, the TEST1 and TEST2 pins are kept at a "0" level by pull-down resistors.

In the open status, the TEST3 and TEST4 pins are kept at a "1" level by pull-up resistors.

The Test pin function is as shown in the following table.

TEST select function 1

Switch Pin Name		ne	Onersting mode	
TEST1	TEST2	TEST3	Operating mode	
0 (or Open)	0 (or Open)	1 (or Open)	Normal function	
Φ(Pulse)	1	1 (or Open)	Input pulses to the 16.384KHz system of the circuit.	
1	Φ(Pulse)	1 (or Open)	Input pulses to the 16.384KHz system of the circuit.	
1	$\Phi(Pulse)$	0	Input pulses to the 64Hz system of the circuit.	
Φ(Pulse)	1	0	Input pulses to the 64Hz system of the circuit.	
Φ(Pulse)	0 (or Open)	0	Input pulses for the minute and hour counters, which advances 1 count with 1 pulse. No carry functions for hour and minute counters.	

TEST select function 2

	Switch P	Pin Name		On anti-on made
TEST3	DIM	CONT1 CONT2		Operating mode
0	Φ(Pulse)			The pulse widths of the all segment outputs are controlled by the pulse width of the DIM signal
0	0	*	*	Sets all segment outputs to high impedance

Note: "*" Indicates that the input level can be "0" and "1"



Three illumination level set pins, DIM, CONT1 and CONT2 are provided to give control over the display brightness level, as shown in the following table.

S	witch Pin Nan	пе	Operating mode	
DIM	CONT1	CONT2	Operating mode	
0 (or Open)	*	*	100% duty display	
1	0 (or Open)	1 (or Open)	25% (1/4) duty display at 4096Hz	
1	0 (or Open)	0	12.5% (1/8) duty display at 4096Hz	
1	1	1 (or Open)	6.25% (1/16) duty display at 4096Hz	

Note: "1" high level, "0" low level, "*" don't care

Device Functions

Reset

Although the device is provided with an external reset pin A/C, the device will in fact reset itself when power is applied, eliminating the need for external reset components. The usual provision of an external capacitor is not required as an internal reset capacitor is integrated within the device.

· Chatter removal

The device contains circuits which are connected to input pins HS, MS and ZA to remove chatter of less than 31.25ms.

Oscillator

The basic time base frequency for this device is determined by an external 4.194304MHz crystal. When an external crystal along with two small external capacitors are connected to the two oscillator pins, the internal oscillator circuit will ensure generation of the correct time base signals. The oscillation frequency, although determined by the external crystal frequency, will also be influenced by the external capacitors, the crystal inherent capacitance and the residual capacitance of the external PCB tracks. To ensure accurate frequency generation, the crystal specification should be taken into account and care taken to place the external capacitors and crystal as close to the device as possible.

Time Adjustment Operation

· Hour/minute adjustment

Both the minutes and hour displays can be adjusted separately or both together in a fast forward format. The hour set pin, HS, and the minutes set pin, MS, are used to make these adjustments. Both of these pins are connected to internal pull-low resistors. Each time one of these lines is pulled high, the respective hour or minute value will increment by one, also if the line is continuously held high then the respective value will increment automatically at a rate of 2Hz. Both values will increment together if both lines are pulled high simultaneously. Note that no carry functions will be implemented when either the hour or minute value overflows.

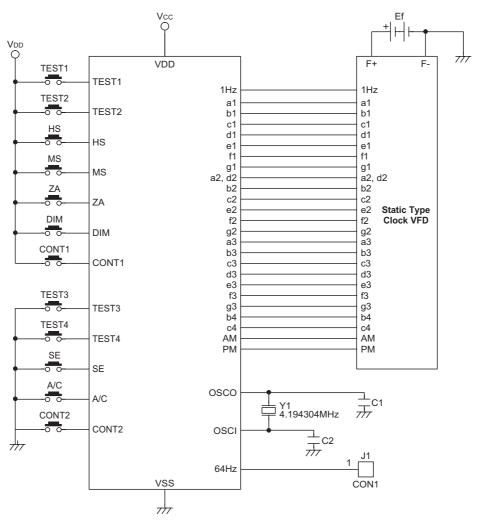
· Zero adjustment

A zero adjust function is also included within the device and is controlled by the ZA pin. This pin is connected to an internal pull low resistor. Pulling this line high will reset both the internal minutes and seconds value, however the way in which the display is reset depends upon the present value of display. If the minute value is presently less than 30 the only the second and minute values will be reset to zero and the hour value remain unchanged. However if the minute value is presently at a value of 30 or higher then when the zero adjustment function is executed, a carry will be implemented and the hour value will be increment by one. The following table illustrates a few examples of this operation.

Zero Adjust Examples							
Pre	esent Tir	ne	After Zero Adjust				
Hr.	Min.	Sec.	Hr.	Min.	Sec.		
1	30	00	2	00	00		
2	00	00	2	00	00		
2	29	59	2	00	00		
2	30	00	3	00	00		
2	59	59	3	00	00		
3	29	59	3	00	00		



Application Circuits

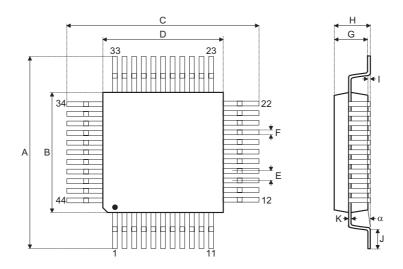


Note: Capacitors C1 and C2 can adjust the frequency accuracy



Package Information

44-pin QFP (10×10) Outline Dimensions



S. mah al		Dimensions in mm					
Symbol	Min.	Nom.	Max.				
Α	13	_	13.4				
В	9.9	_	10.1				
С	13	_	13.4				
D	9.9	_	10.1				
E	_	0.8	_				
F	_	0.3	_				
G	1.9	_	2.2				
Н	_	_	2.7				
1	_	0.1	_				
J	0.73	_	0.93				
K	0.1	_	0.2				
α	0°	_	7°				



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